

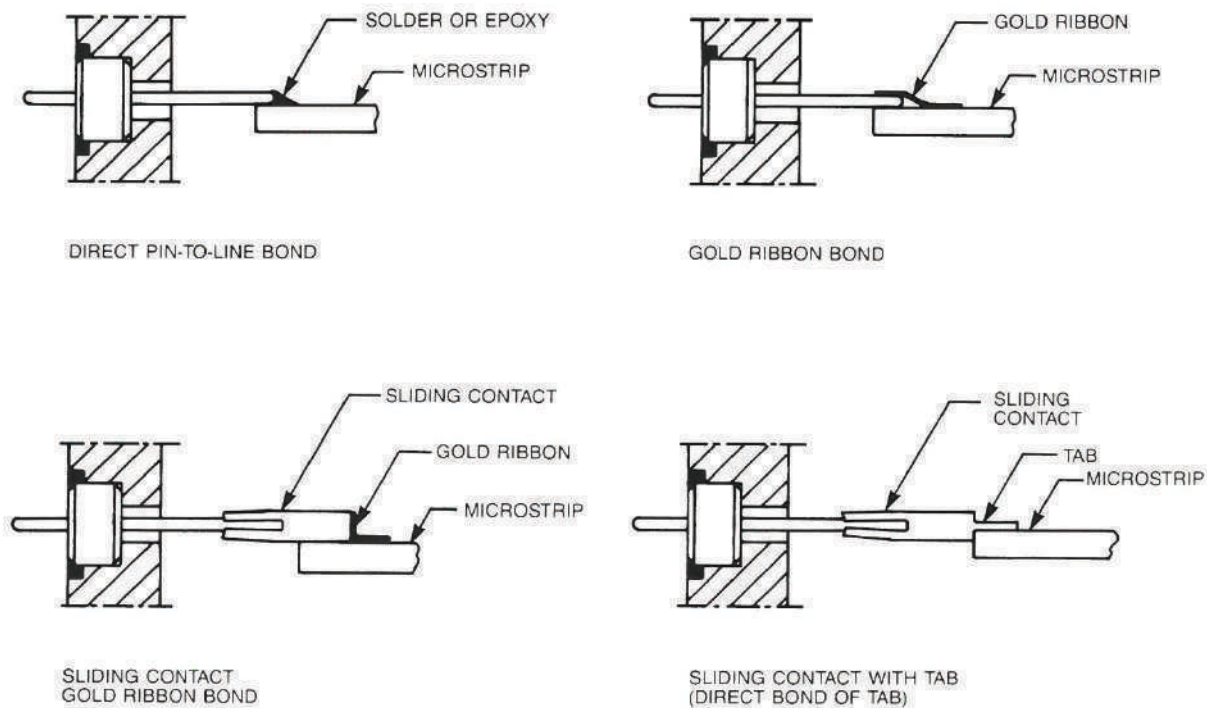
APPLICATION NOTES

THE COAXIAL LINE TO MICROSTRIP INTERFACE (continued)

Figure B shows some of the more common methods of pin attachment: solder, gold ribbon bonding (commonly bonded by ultrasonic welding) and conductive epoxy. Mechanical pressure is sometimes used to hold the pin in contact with the line; this eliminates heating the circuit during attachment.

FIGURE B

PIN TO LINE ATTACHMENT METHODS



(Proportions altered to illustrate detail.)